

## Molding Type Module IGBT, 2-in-1 Package, 1200 V and 300 A


**Double INT-A-PAK**

**RoHS  
COMPLIANT**

### FEATURES

- 10  $\mu$ s short circuit capability
- $V_{CE(on)}$  with positive temperature coefficient
- Maximum junction temperature 150 °C
- Low switching losses
- Rugged with ultrafast performance
- Low inductance case
- Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

### TYPICAL APPLICATIONS

- Switching mode power supplies
- Inductive heating
- Electronic welder

### DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as electronic welder and inductive heating.

| PRODUCT SUMMARY  |                  |
|--|------------------|
| $V_{CES}$  | 1200 V           |
| $I_C$ at $T_C = 80\text{ }^\circ\text{C}$                                      | 300 A            |
| $V_{CE(on)}$ (typical)<br>at $I_C = 300\text{ A}$ , $25\text{ }^\circ\text{C}$ | 3.10 V           |
| Speed  | 8 kHz to 30 kHz  |
| Package  | Double INT-A-PAK |
| Circuit  | Half bridge      |

| ABSOLUTE MAXIMUM RATINGS ( $T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted) |                |   |          |         |
|---|----------------|---|----------|---------|
| PARAMETER   | SYMBOL         | TEST CONDITIONS                         | MAX.     | UNITS   |
| Collector to emitter voltage  | $V_{CES}$      |   | 1200     | V       |
| Gate to emitter voltage   | $V_{GES}$      |   | $\pm 20$ |         |
| Collector current   | $I_C$          | $T_C = 25\text{ }^\circ\text{C}$        | 530      | A       |
|   |                | $T_C = 80\text{ }^\circ\text{C}$        | 300      |         |
| Pulsed collector current  | $I_{CM}^{(1)}$ | $t_p = 1\text{ ms}$                     | 600      |         |
| Diode continuous forward current  | $I_F$          | $T_C = 80\text{ }^\circ\text{C}$        | 300      |         |
| Diode maximum forward current   | $I_{FM}$       | $t_p = 1\text{ ms}$                     | 600      |         |
| Maximum power dissipation   | $P_D$          | $T_J = 150\text{ }^\circ\text{C}$       | 2119     |         |
| Short circuit withstand time  | $t_{SC}$       | $T_J = 125\text{ }^\circ\text{C}$       | 10       | $\mu$ s |
| RMS isolation voltage   | $V_{ISOL}$     | $f = 50\text{ Hz}$ , $t = 1\text{ min}$ | 2500     | V       |

**Note**

<sup>(1)</sup> Repetitive rating: pulse width limited by maximum junction temperature.



| <b>IGBT ELECTRICAL SPECIFICATIONS</b> ( $T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted) |               |   |      |      |      |       |
|--|---------------|---|------|------|------|-------|
| PARAMETER  | SYMBOL        | TEST CONDITIONS   | MIN. | TYP. | MAX. | UNITS |
| Collector to emitter breakdown voltage   | $V_{(BR)CES}$ | $T_J = 25\text{ }^\circ\text{C}$  | 1200 | -    | -    | V     |
| Collector to emitter voltage   | $V_{CE(on)}$  | $V_{GE} = 15\text{ V}, I_C = 300\text{ A}, T_J = 25\text{ }^\circ\text{C}$  | -    | 3.10 | 3.60 |       |
|  |               | $V_{GE} = 15\text{ V}, I_C = 300\text{ A}, T_J = 125\text{ }^\circ\text{C}$ | -    | 3.45 | -    |       |
| Gate to emitter threshold voltage  | $V_{GE(th)}$  | $V_{CE} = V_{GE}, I_C = 3.0\text{ mA}, T_J = 25\text{ }^\circ\text{C}$      | 4.4  | 5.2  | 6.0  |       |
| Collector cut-off current  | $I_{CES}$     | $V_{CE} = V_{CES}, V_{GE} = 0\text{ V}, T_J = 25\text{ }^\circ\text{C}$     | -    | -    | 5.0  | mA    |
| Gate to emitter leakage current  | $I_{GES}$     | $V_{GE} = V_{GES}, V_{CE} = 0\text{ V}, T_J = 25\text{ }^\circ\text{C}$     | -    | -    | 400  | nA    |

| <b>SWITCHING CHARACTERISTICS</b>         |               |   |      |      |      |            |
|--|---------------|---|------|------|------|------------|
| PARAMETER                                | SYMBOL        | TEST CONDITIONS   | MIN. | TYP. | MAX. | UNITS      |
| Turn-on delay time                       | $t_{d(on)}$   | $V_{CC} = 600\text{ V}, I_C = 300\text{ A}, R_g = 3.3\text{ }\Omega, V_{GE} = \pm 15\text{ V}, T_J = 25\text{ }^\circ\text{C}$                | -    | 662  | -    | ns         |
| Rise time                                | $t_r$         |   | -    | 142  | -    |            |
| Turn-off delay time                      | $t_{d(off)}$  |   | -    | 633  | -    |            |
| Fall time                                | $t_f$         |   | -    | 117  | -    |            |
| Turn-on switching loss                   | $E_{on}$      | $V_{CC} = 600\text{ V}, I_C = 300\text{ A}, R_g = 3.3\text{ }\Omega, V_{GE} = \pm 15\text{ V}, T_J = 125\text{ }^\circ\text{C}$               | -    | 19.7 | -    | mJ         |
| Turn-off switching loss                  | $E_{off}$     |   | -    | 22.4 | -    |            |
| Turn-on delay time                       | $t_{d(on)}$   |   | -    | 660  | -    |            |
| Rise time                                | $t_r$         |   | -    | 143  | -    |            |
| Turn-off delay time                      | $t_{d(off)}$  | $V_{CC} = 600\text{ V}, I_C = 300\text{ A}, R_g = 3.3\text{ }\Omega, V_{GE} = \pm 15\text{ V}, T_J = 125\text{ }^\circ\text{C}$               | -    | 665  | -    | ns         |
| Fall time                                | $t_f$         |   | -    | 137  | -    |            |
| Turn-on switching loss                   | $E_{on}$      |   | -    | 24.9 | -    |            |
| Turn-off switching loss                  | $E_{off}$     |   | -    | 28.4 | -    |            |
| Input capacitance                        | $C_{ies}$     | $V_{GE} = 0\text{ V}, V_{CE} = 30\text{ V}, f = 1.0\text{ MHz}$   | -    | 25.3 | -    | nF         |
| Output capacitance                       | $C_{oes}$     |   | -    | 2.25 | -    |            |
| Reverse transfer capacitance             | $C_{res}$     |   | -    | 0.91 | -    |            |
| SC data                                  | $I_{SC}$      | $t_{sc} \leq 10\text{ }\mu\text{s}, V_{GE} = 15\text{ V}, T_J = 125\text{ }^\circ\text{C}, V_{CC} = 600\text{ V}, V_{CEM} \leq 1200\text{ V}$ | -    | 2550 | -    | A          |
| Internal gate resistance                 | $R_{gint}$    |   | -    | 1.2  | -    | $\Omega$   |
| Stray inductance                         | $L_{CE}$      |   | -    | -    | 18   | nH         |
| Module lead resistance, terminal to chip | $R_{CC'+EE'}$ | $T_C = 25\text{ }^\circ\text{C}$  | -    | 0.32 | -    | m $\Omega$ |

| <b>DIODE ELECTRICAL SPECIFICATIONS</b> ( $T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted) |           |   |                                   |      |      |       |               |
|---|-----------|---|-----------------------------------|------|------|-------|---------------|
| PARAMETER   | SYMBOL    | TEST CONDITIONS   | MIN.                              | TYP. | MAX. | UNITS |               |
| Diode forward voltage   | $V_F$     | $I_F = 300\text{ A}$  | $T_J = 25\text{ }^\circ\text{C}$  | -    | 1.82 | 2.25  | V             |
|   |           |   | $T_J = 125\text{ }^\circ\text{C}$ | -    | 1.95 | -     |               |
| Diode reverse recovery charge   | $Q_{rr}$  | $I_F = 300\text{ A}, V_R = 600\text{ V}, dI/dt = -2125\text{ A}/\mu\text{s}, V_{GE} = -15\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$  | -    | 21.5 | -     | $\mu\text{C}$ |
|   |           |   | $T_J = 125\text{ }^\circ\text{C}$ | -    | 32.4 | -     |               |
| Diode peak reverse recovery current   | $I_{rr}$  | $I_F = 300\text{ A}, V_R = 600\text{ V}, dI/dt = -2125\text{ A}/\mu\text{s}, V_{GE} = -15\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$  | -    | 178  | -     | A             |
|   |           |   | $T_J = 125\text{ }^\circ\text{C}$ | -    | 225  | -     |               |
| Diode reverse recovery energy   | $E_{rec}$ | $I_F = 300\text{ A}, V_R = 600\text{ V}, dI/dt = -2125\text{ A}/\mu\text{s}, V_{GE} = -15\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$  | -    | 10.4 | -     | mJ            |
|   |           |   | $T_J = 125\text{ }^\circ\text{C}$ | -    | 16.6 | -     |               |



| THERMAL AND MECHANICAL SPECIFICATIONS |            |                           |            |       |       |       |
|---------------------------------------|------------|---------------------------|------------|-------|-------|-------|
| PARAMETER                             | SYMBOL     | TEST CONDITIONS           | MIN.       | TYP.  | MAX.  | UNITS |
| Operating junction temperature range  | $T_J$      |                           | -          | -     | 150   | °C    |
| Storage temperature range             | $T_{STG}$  |                           | -40        | -     | 125   |       |
| Junction to case                      | IGBT       |                           |            |       | 0.059 | K/W   |
|                                       | Diode      |                           |            |       |       |       |
| Case to sink                          | $R_{thCS}$ | Conductive grease applied | -          | 0.035 | -     |       |
| Mounting torque                       |            | Power terminal screw: M6  | 2.5 to 5.0 |       |       |       |
|                                       |            | Mounting screw: M6        | 3.0 to 6.0 |       |       |       |
| Weight                                |            |                           | 300        |       |       | g     |

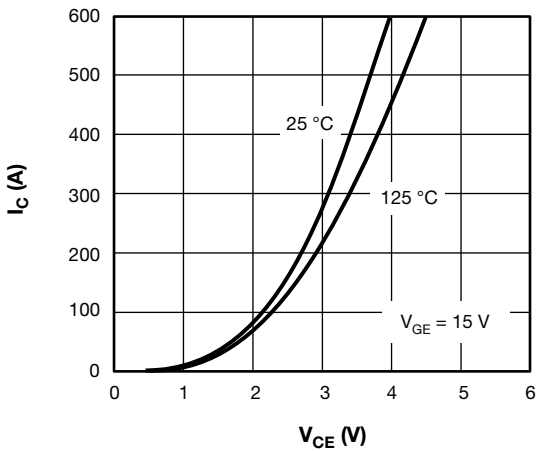


Fig. 1 - IGBT Typical Output Characteristics

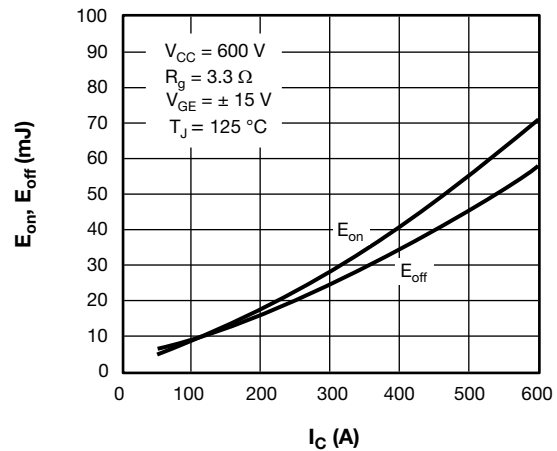


Fig. 3 - IGBT Switching Loss vs.  $I_C$

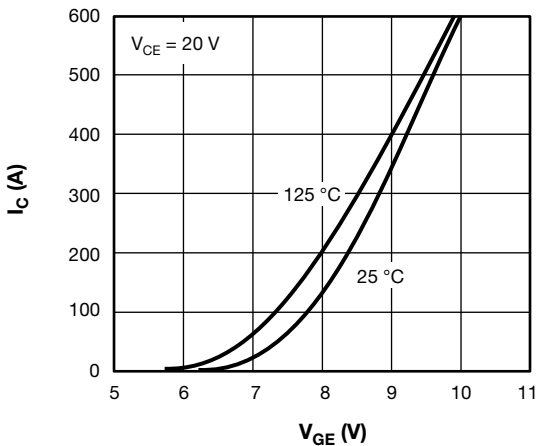


Fig. 2 - IGBT Typical Transfer Characteristics

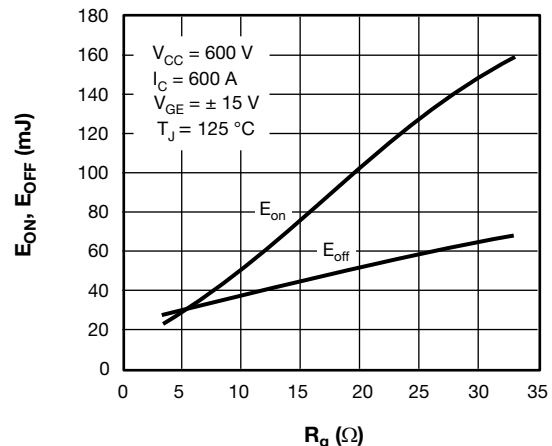
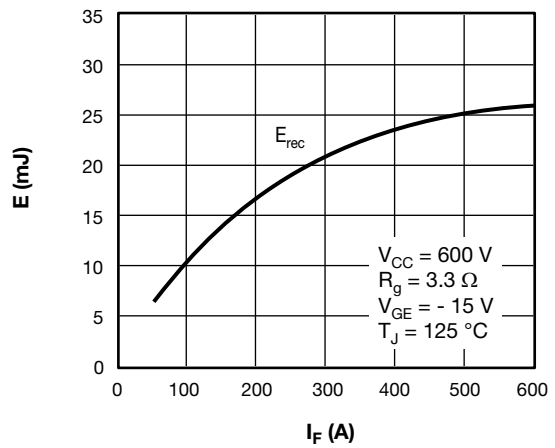
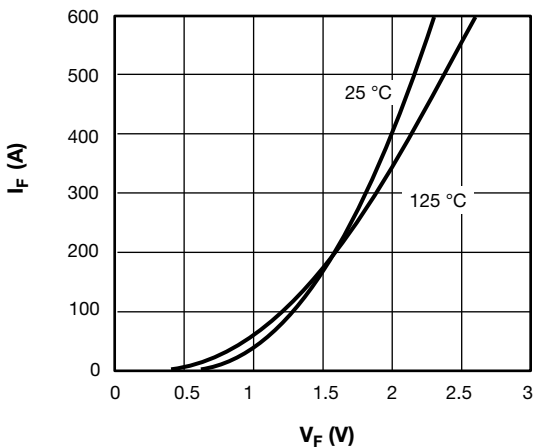
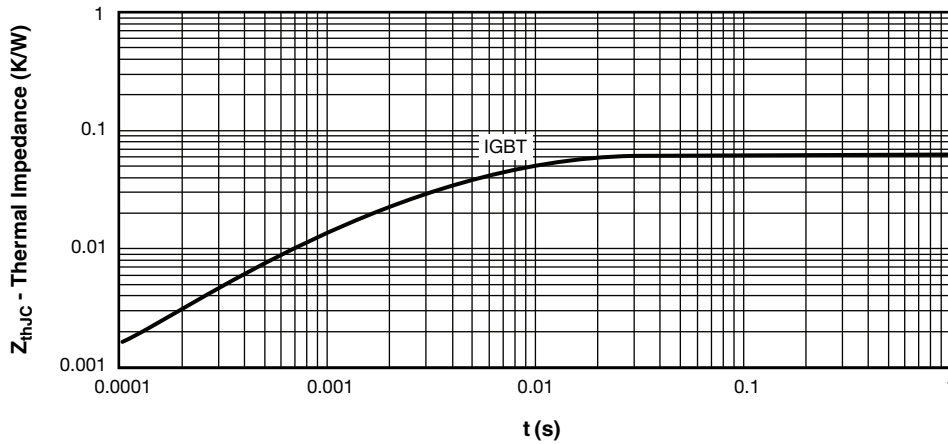
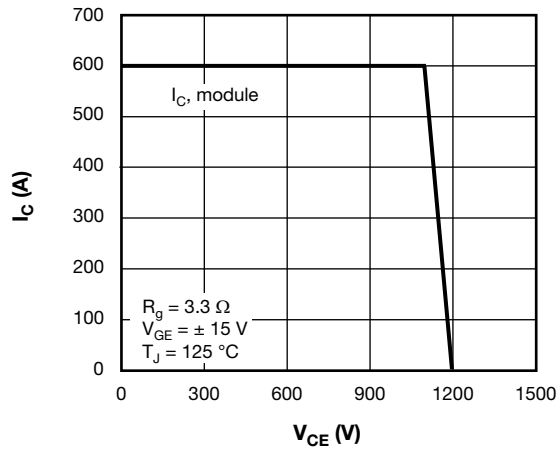


Fig. 4 - IGBT Switching Loss vs.  $R_g$



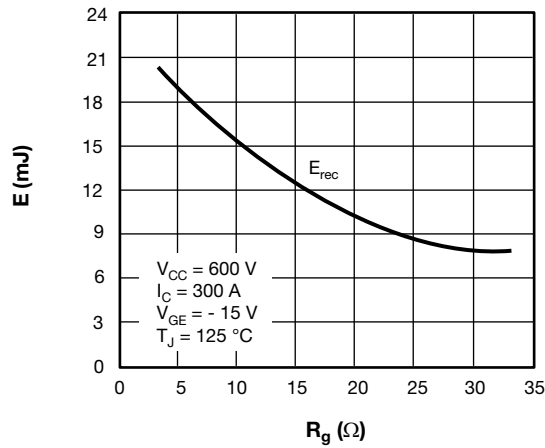


Fig. 9 - Diode Switching Loss vs. Gate Resistance

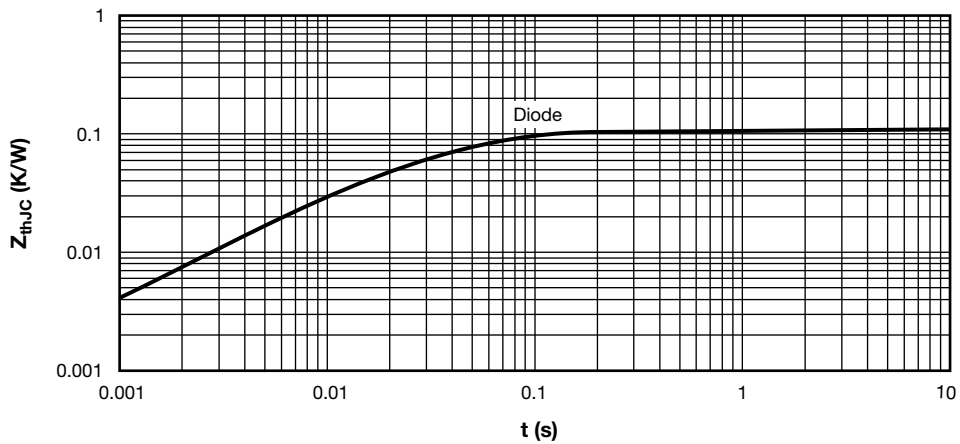
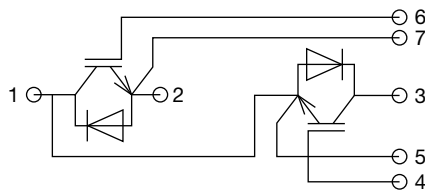


Fig. 10 - Diode Transient Thermal Impedance

**CIRCUIT CONFIGURATION**

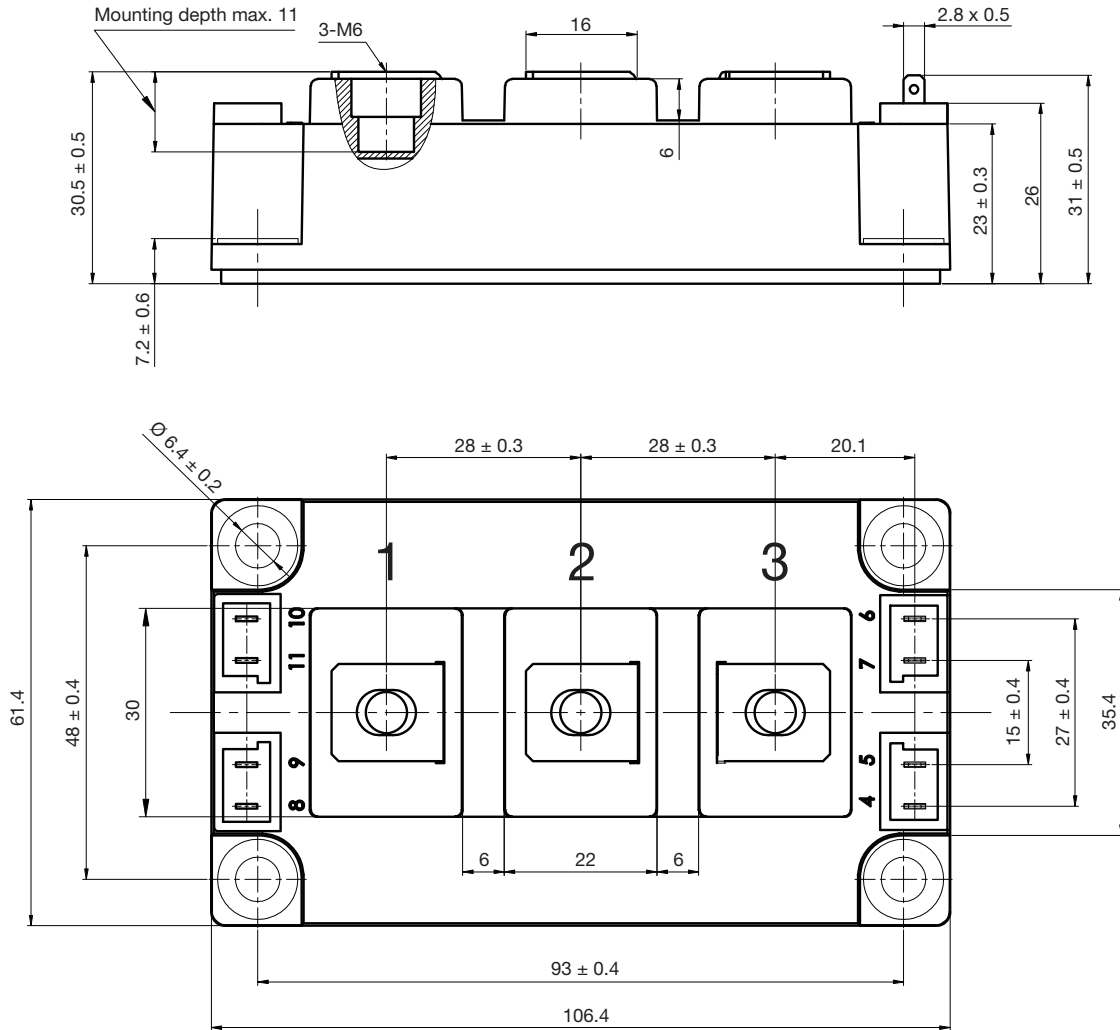


| LINKS TO RELATED DOCUMENTS |  |
|----------------------------|--|
| Dimensions                 | <a href="http://www.vishay.com/doc?95525">www.vishay.com/doc?95525</a> |



## Double INT-A-PAK

**DIMENSIONS** in millimeters (inches)





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